





产品规格书

Product Name: High Inrush Current Surface Mount Chip Fuse

AEM Part Number: F0603HI5000V032T

Customer: 深圳市裕富照明有限公司

Revision: 5

Date: 2013-12-10

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| Checked by | Approved by | Accepted by customer |
|--------------|--------------|----------------------|
| Dongming Tan | Dongming Tan | 深圳市裕富照明有限公司 |
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High Inrush Current Surface Mount Chip Fuse

耐浪涌片式熔断器

AEM Part Number: F0603HI5000V032T

1 Operating Temperature Range

-55°C ~ +125°C (with de-rating)

2 Ratings

| AEM Part Number | Current Rating (A) | Voltage Rating (VDC) | Nominal Cold DCR $(\Omega)^1$ | DCR Min (Ω) | DCR Max (Ω) | Nominal I ² t (A ² s) ² |
|------------------|-----------------------|----------------------------|-------------------------------|-------------------|-------------------|--|
| F0603HI5000V032T | 5.0 | 32 | 0.013 | 0.009 | 0.017 | 3.25 |

^{1.} Measured at \leq 10% of rated current and 25°C ambient.

3 Clear-Time Characteristics:

| % of current rating | Clear-time at 25 ℃ | | |
|---------------------|----------------------|----------------------|--|
| 100% | 4 hours (min) | | |
| 200% | 1 second (min) | 60 seconds (max) | |
| 1000% | 0.0002 seconds (min | 0.02 seconds (max) | |

4 Interrupting Rating:

50A at rated voltage

5 Marking(Optional):

Without marking

6 Agency Approval:

Recognized Under the Components Program of Underwriters Laboratories.

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^{2.} Melting I2t at 1000% current rating



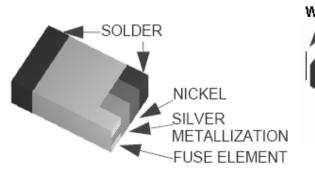
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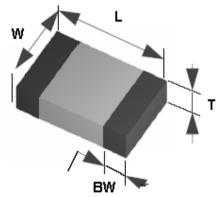
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7 Shape and Dimensions: Inch (mm)





| Size | L | W | Т | BW |
|-------------|-------------|-------------|-------------|-------------|
| 0603 (1608) | 0.063±0.006 | 0.031±0.006 | 0.031±0.006 | 0.014±0.006 |
| | (1.60±0.15) | (0.80±0.15) | (0.80±0.15) | (0.36±0.15) |

8 Product Identification

F 0603 HI 5000 V032 T

(1) (2) (3) (4) (5) (6)

(1) Series code: F - Chip Fuse

(2) Dimension code: L x W (inch)

The first two digits - L (length)

The last two digits - W (width)

(3) Characteristic code: HI - High Inrush

(4) Current rating code: 5000 - 5000 mA

(5) Voltage rating code: V032 - 32 VDC

(6) Package code:

T - Tape & Reel

B - Bulk

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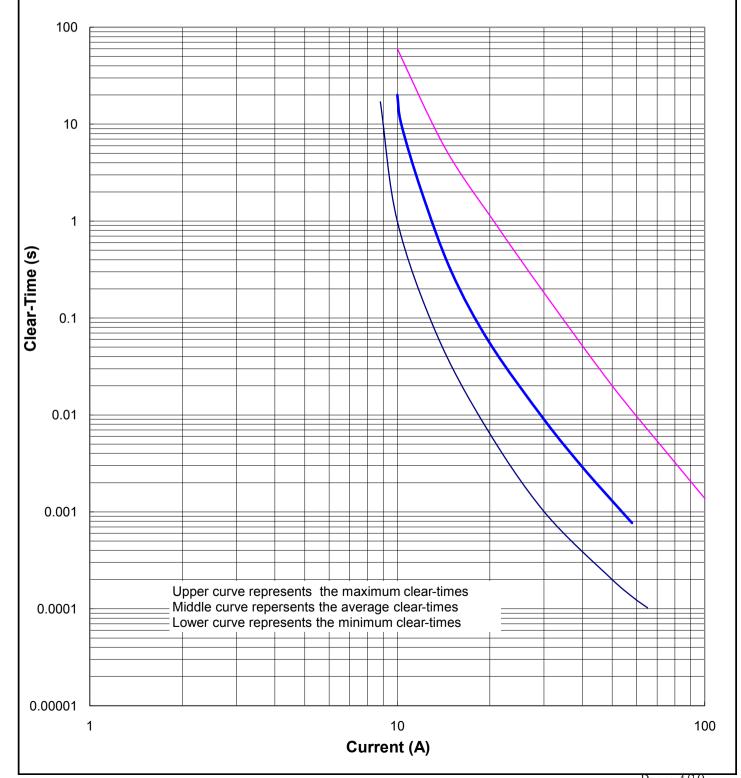
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9 Clear Time Curves:

F0603HI5000V032T





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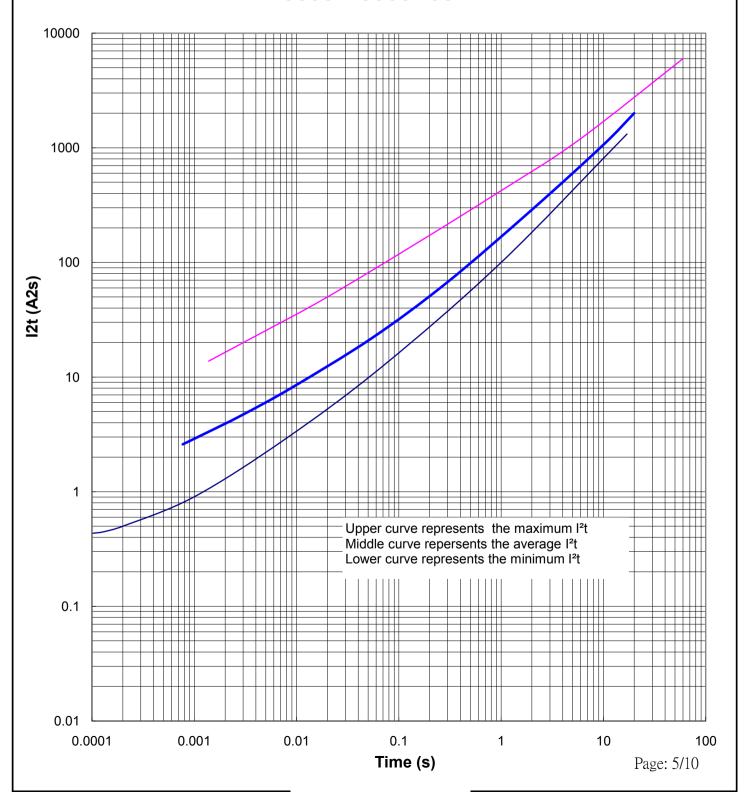
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AEM Part Number: F0603HI5000V032T

10 I²t vs t Curves:

F0603HI5000V032T





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11 Features

- 11.1 High inrush current withstanding capability
- 11.2 Mutilayer monolithic structure with glass ceramic body and silver fusing element
- 11.3 Silver termination with nickel and solder plating (lead free), providing excellent solderability
- 11.4 Compatible with both wave and reflow soldering processes

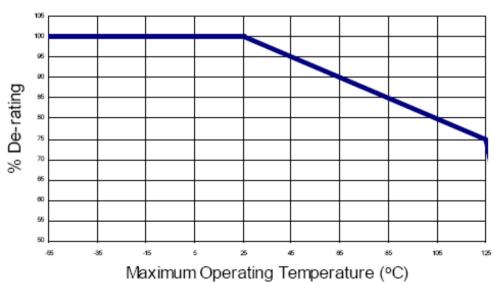
12 Typical Applications

- 12.1 Consumer Electronics, e.g. CD-/LD-Disc drives, portable sets (drives)
- 12.2 Communication Technology, e.g. ISDN-line card protection, PCM-cards, mobile phones tuner input, satellite receivers, cards in GSM-base stations
- 12.3 Data-Processing, e.g. disc drives, keyboard/mouse ports, LAN-/PC-cards, modems
- 12.4 Measurement and Control Technology, e.g. communication ports, measurement inputs/probes/sensors, analysis units, PLCs
- 12.5 Medical Technology, e.g. communication ports, measurement in & out probes
- 12.6 Power Supply Technology, e.g. low voltage section of power-supplies/chargers

13 Temperature De-rating Guideline

The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than $25\,^{\circ}$ C, the fuse shall be "de-rated" according to the de-rating curve.

Temperature Effect on Current Rating



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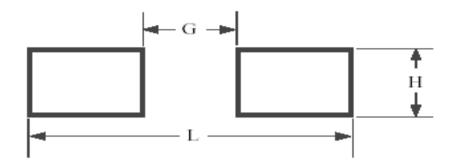
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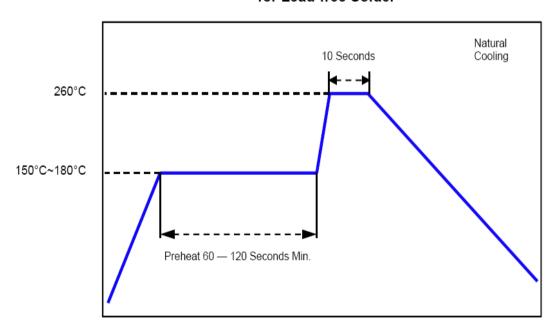
14 Recommended PC Board Land Pattern

| Chip Size | L | G | Н | |
|-------------|--------------|--------------|--------------|--|
| Chip Size | INCH (mm) | INCH (mm) | INCH (mm) | |
| 0603 (1608) | 0.087 (2.20) | 0.031 (0.80) | 0.039 (1.00) | |



15 Recommended Temperature Profile for Reflow Soldering

Recommended Temperature Profile for Lead-free Solder



Recommended conditions for hand soldering:

- 1. Appropriate temperature (max.) of soldering iron tip/soldering time (max.): 280°C /10 s or 350°C / 3 s
- 2. Using hot air rework station with tip that can melt the solder on both terminations at the same time is strongly recommended. Do not directly contact the chip termination with the tip of soldering iron.

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16 Special Measuring Equipment

16.1 Clear Time

Clear time is measured with clear time tester.

16.2 DC Resistance

DC resistance is measured with Keithley 580/Keithley 2010.

16.3 Interrupting Capability

Interrupting capability is measured with short circuit tester.

17 Reliability Tests

| Reliability Test | Test Condition and Requirement |
|---------------------------|--|
| Bending | Board: 94x94x1.6 mm, 2 mm bend for 5 seconds, 20% DCR change max. |
| Solderability | 255°C, 5 seconds, 95% coverage min. |
| Soldering Heat Resistance | 260°C, 60 seconds, 10% DCR change max. |
| Terminal Strength | 0603 – 0.5 kg 30 second hanging, no damage |
| Life | 25°C, 2000 hours, 80% rated current, no open circuit,voltage drop change≤±10%. |
| Thermal Shock | -65°C to +125°C, 100 cycles, no mechanical damage, 10% DCR change max. |
| Mechanical Vibration | 5 – 3000 Hz, 0.4 inch double amplitude or 30 G peak, 10% DCR change max. |
| Mechanical Shock | 1500 G, 0.5 milliseconds, half-sine shocks 10% DCR change max. |
| Salt Spray | 5% salt solution, 48 hour exposure |
| Moisture Resistance | 10 cycles, 10% DCR change max., no excessive corrosion |

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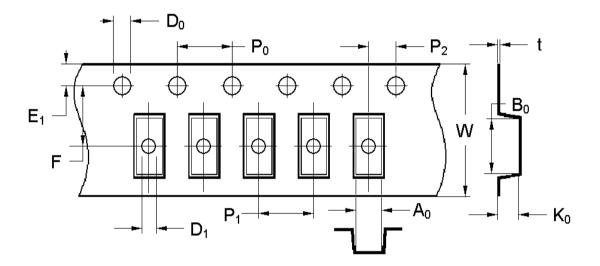
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18 Packaging

18.1 Surface mount chip fuses are provided on tape-and-reel for use in pick-and-place machines or in bulk for special applications. The reel size is 7 inches.

18.2 Tape Dimensions: Inch (mm)



| Size | Ao | Во | Ko | Туре |
|--------|---------------|---------------|-------------------|-------|
| 0603 | 0.039 ± 0.004 | 0.071 ± 0.004 | 0.037 ± 0.003 | Danar |
| (1608) | (1.00 ± 0.10) | (1.80 ± 0.10) | (0.95 ± 0.08) | Paper |

| E1 | F | W | P1 | P0 | P2 | D0 | D1 | t |
|---------------|---------------|----------------------|---------------|---------------|---------------|---------------------|-----|---------------|
| 0.069 ± 0.004 | 0.138 ± 0.002 | 0.319 <u>+</u> 0.008 | 0.157 ± 0.004 | 0.157 ± 0.004 | 0.079 ± 0.002 | 0.059 + 0.004/-0.00 | N/A | 0.009 ± 0.001 |
| (1.75 ± 0.10) | (3.50 ± 0.05) | (8.10±0.20) | (4.00 ± 0.10) | (4.00 ± 0.10) | (2.00 ± 0.05) | (1.50 + 0.10/-0.00) | | (0.23 ± 0.02) |

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18.3 Quantity Per Reel

| Chip Size | Parts on 7 inch (178 mm) Reel |
|-------------|----------------------------------|
| 0603 (1608) | 4,000 |

Other sizes and chip quantities can be provided upon customer's request.

19 Storage

- 19.1 The maximum ambient temperature shall not exceed 35 °C.Storage temperature higher than 35 °C could result in the deformation of packaging materials.
- 19.2 The maximum relative humidity recommended for storage is 75%. High humidity with high temperature could accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components.
- 19.3 The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present.

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单击下面可查看定价,库存,交付和生命周期等信息

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